

Features

| | |
|------------------|--|
| Package | Bi-color emitting LED (Red / Yellow Green) Outer dimension: 3.0 x 2.5 x 1.5mm (L x W x H) |
| Product features | <ul style="list-style-type: none"> •Lead-free soldering compatible •RoHS compliant |

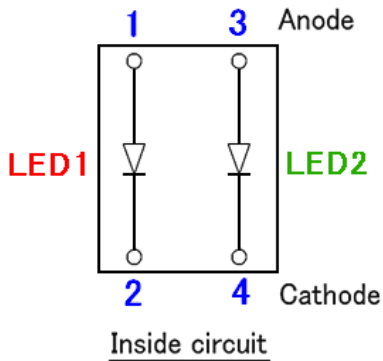
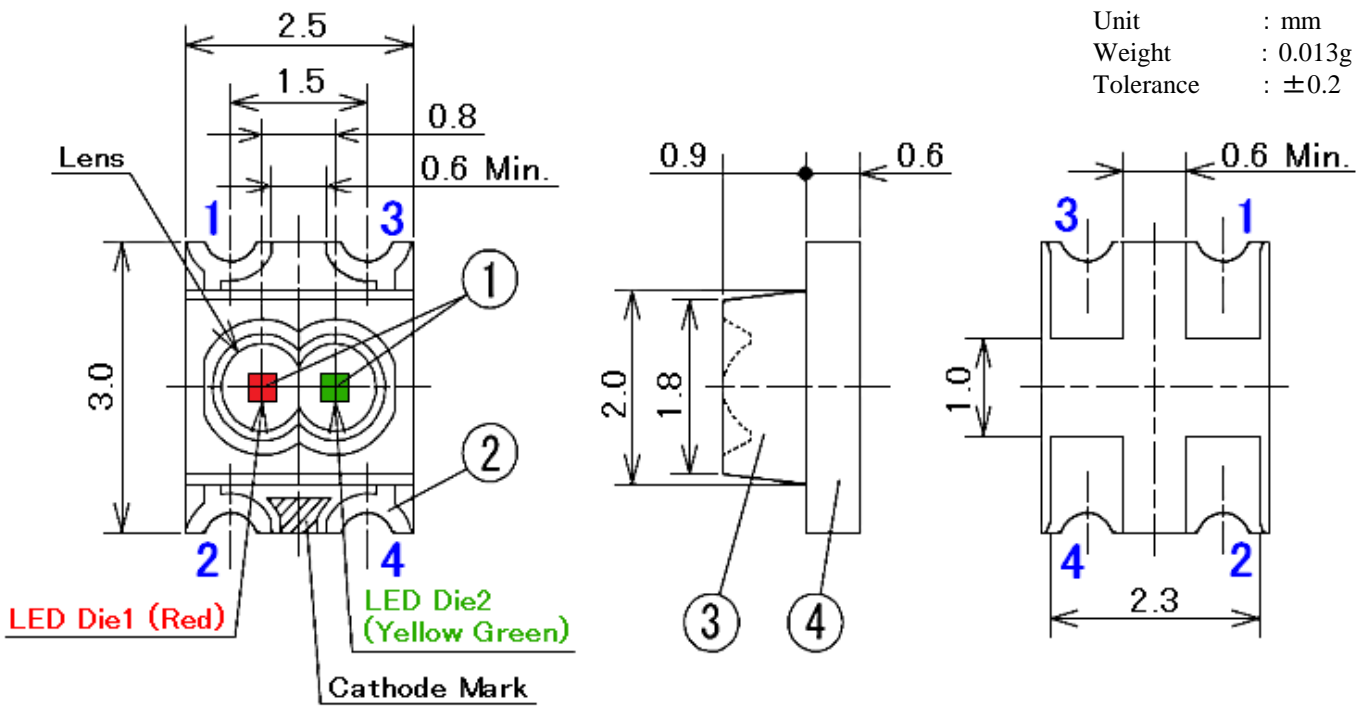
Recommended Applications

- Light source for various indicator, switch etc.

Outline Dimensions

DRD1204W-TR

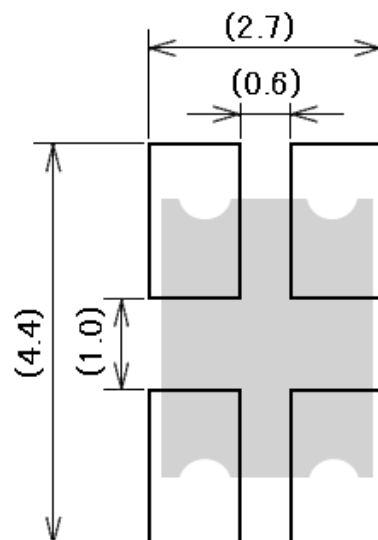
Unit : mm
 Weight : 0.013g
 Tolerance : ±0.2



| No. | Item | Material | Qty. |
|-----|------------|---------------------|------|
| ① | LED Die | AlGaInP | 2 |
| ② | Electrode | Copper (Au Plating) | 4 |
| ③ | Mold Resin | Epoxy Resin | 1 |
| ④ | PCB | Glass fabrics | 1 |

Recommended soldering Pattern

Unit : mm



【 Product Overview 】

| | | |
|-----------------------------|-------------|--------------|
| ITEM | LED Die 1 | LED Die 2 |
| DIE MATERIAL | AlGaInP | |
| EMITTING COLOR | RED | YELLOW-GREEN |
| RESIN COLOR 【EMITTING AREA】 | WATER CLEAR | |

【 Absolute Maximum Ratings 】

| ITEM | SYMBOL | MAXIMUM RATINGS | | UNITS |
|---|------------------|-----------------|------------|-------|
| | | LED Die(1) | LED Die(2) | |
| Power Dissipation | P_d | 78 | | mW |
| Forward Current | I_F | 30 | | mA |
| Repetitive Peak Forward Current "1ms, 1/20duty" | I_{FRM} | 100 | | mA |
| I_F Derate Linearly from "25°C" | ΔI_F | 0.43 | | mA/°C |
| I_{FRM} Derate Linearly from "25°C" | ΔI_{FRM} | 1.33 | | mA/°C |
| Reverse Voltage | V_R | 5 | | V |
| Operating Temperature | T_{opr} | -40 ~ +85 | | °C |
| Storage Temperature | T_{stg} | -40 ~ +100 | | °C |
| Soldering Temperature "Reflow Soldering" | T_{sld} | 260°C MAX | | |

(Ta=25°C)

Notes 1

Notes 1

Notes 2

Notes

1. Each value described on a list is rating at the time of the single color lighting.

The absolutely maximum rating in the simultaneous lighting, the values should be applied 50% Max. of each values.

2. Please refer to page 9, Soldering Conditions.

【 Electro and Optical Characteristics 】

LED Die(1)

(Ta=25°C)

| ITEM | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|--------------------------|-----------------|---------------------|------|------|------|---------------|
| Forward Voltage | V_F | $I_F = 20\text{mA}$ | - | 2.0 | 2.4 | V |
| Reverse Current | I_R | $V_R = 5\text{V}$ | - | - | 100 | μA |
| Luminous Intensity | I_V | $I_F = 20\text{mA}$ | 100 | - | 340 | mcd |
| Peak Wavelength | λ_p | $I_F = 20\text{mA}$ | - | 635 | - | nm |
| Dominant Wavelength | λ_d | $I_F = 20\text{mA}$ | 621 | 626 | 634 | nm |
| Spectral Line Half Width | $\Delta\lambda$ | $I_F = 20\text{mA}$ | - | 15 | - | nm |

LED Die(2)

(Ta=25°C)

| ITEM | SYMBOL | CONDITIONS | MIN. | TYP. | MAX. | UNITS |
|--------------------------|-----------------|---------------------|------|------|------|---------------|
| Forward Voltage | V_F | $I_F = 20\text{mA}$ | - | 2.0 | 2.4 | V |
| Reverse Current | I_R | $V_R = 5\text{V}$ | - | - | 100 | μA |
| Luminous Intensity | I_V | $I_F = 20\text{mA}$ | 70 | - | 240 | mcd |
| Peak Wavelength | λ_p | $I_F = 20\text{mA}$ | - | 575 | - | nm |
| Dominant Wavelength | λ_d | $I_F = 20\text{mA}$ | 566 | 572 | 578 | nm |
| Spectral Line Half Width | $\Delta\lambda$ | $I_F = 20\text{mA}$ | - | 15 | - | nm |

Notes

Above the table of Luminous Intensity (I_V) values and Dominant wavelength (λ_d) values are the setup value of the selection machine. 【Tolerance : $I_V \dots \pm 10\%$, $\lambda_d \dots \pm 2\text{nm}$ 】

【 Sorting For Luminous Intensity and Dominant Wavelength 】

LED's shall be sorted out into the following ranks of Luminous Intensity and Dominant Wavelength.

Luminous Intensity (I_v) Rank

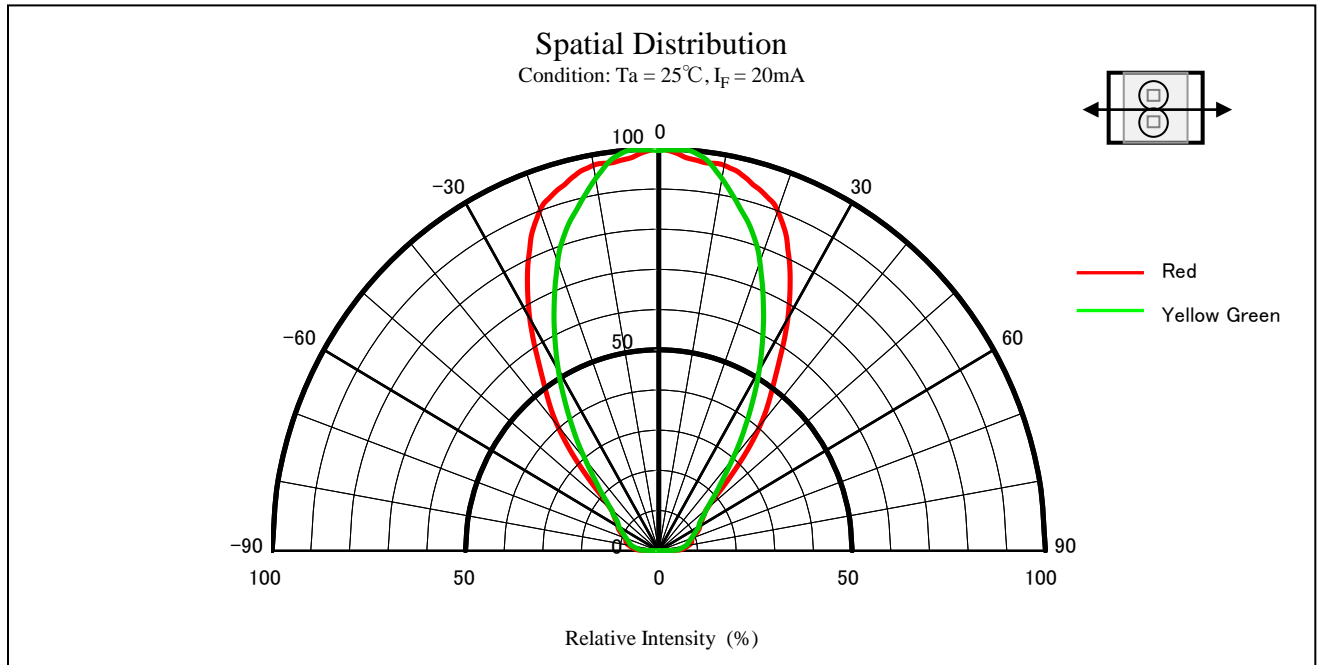
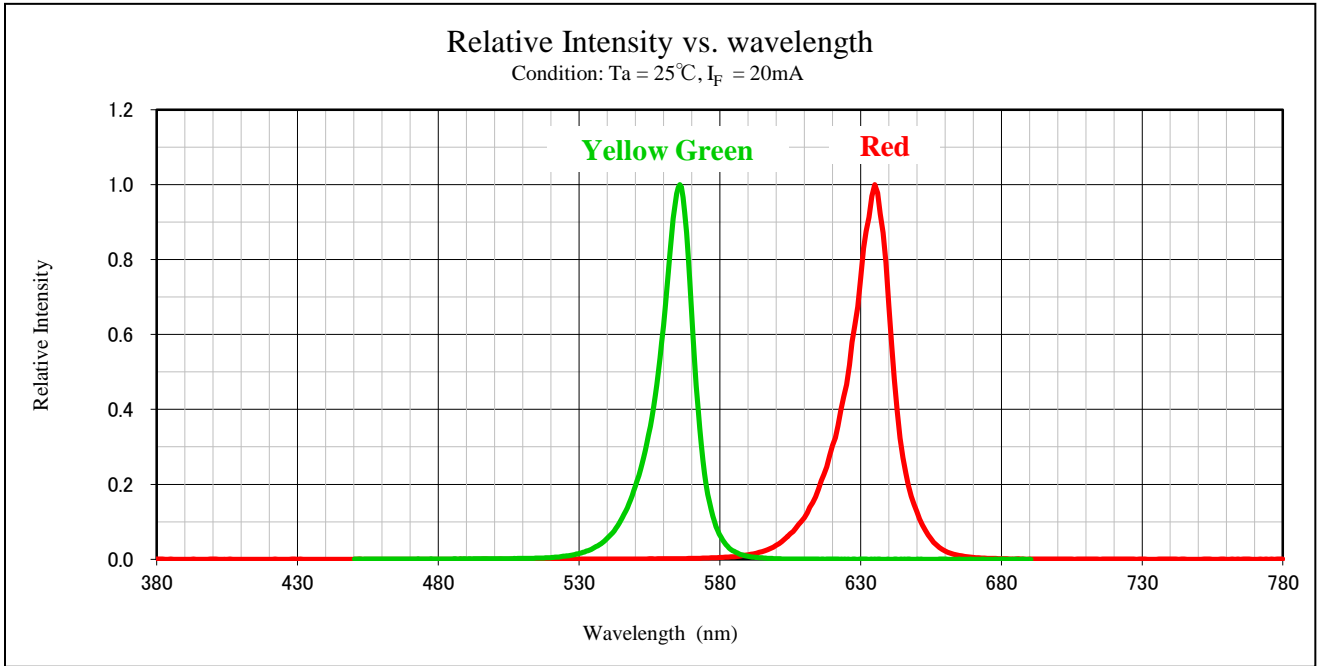
| Rank | I _v (mcd) | | | | CONDITIONS |
|------|----------------------|------|---------------------------|------|--|
| | LED Chip 1 (Red) | | LED Chip 2 (Yellow-Green) | | |
| | MIN. | MAX. | MIN. | MAX. | |
| AA | 100 | 150 | 70 | 105 | I _F =20mA T _a =25°C |
| AB | | | 105 | 160 | |
| AC | | | 160 | 240 | |
| BA | 150 | 225 | 70 | 105 | |
| BB | | | 105 | 160 | |
| BC | | | 160 | 240 | |
| CA | 225 | 340 | 70 | 105 | |
| CB | | | 105 | 160 | |
| CC | | | 160 | 240 | |

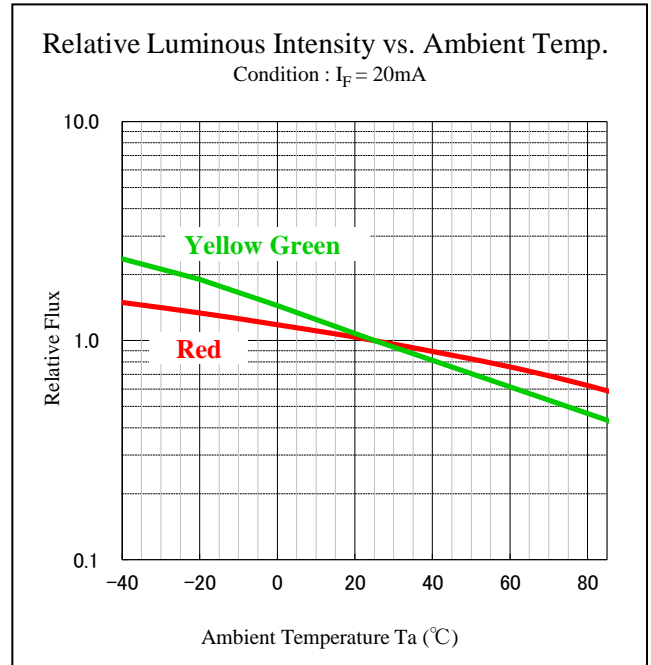
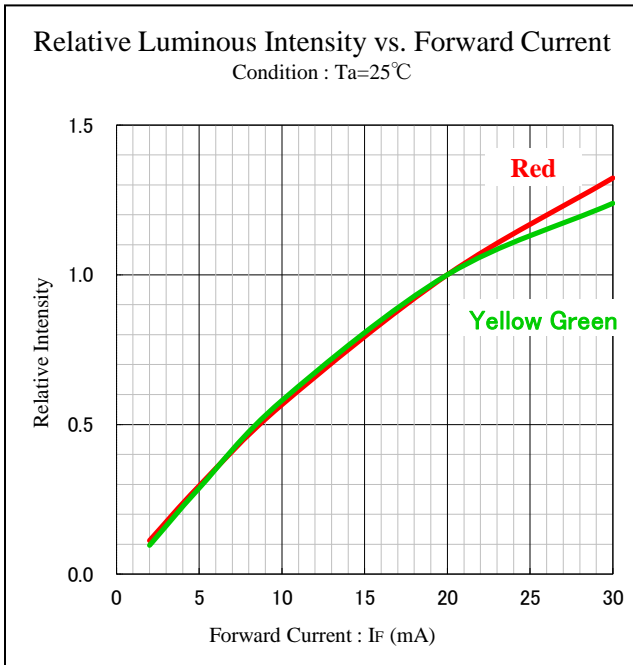
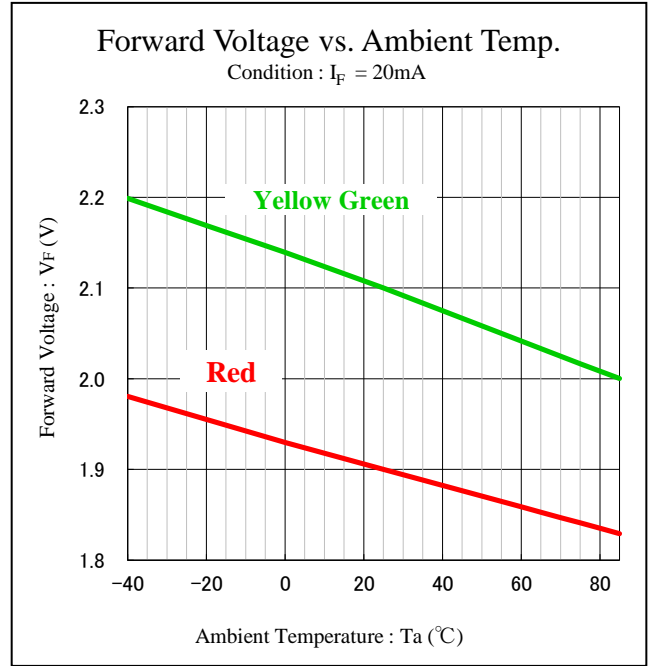
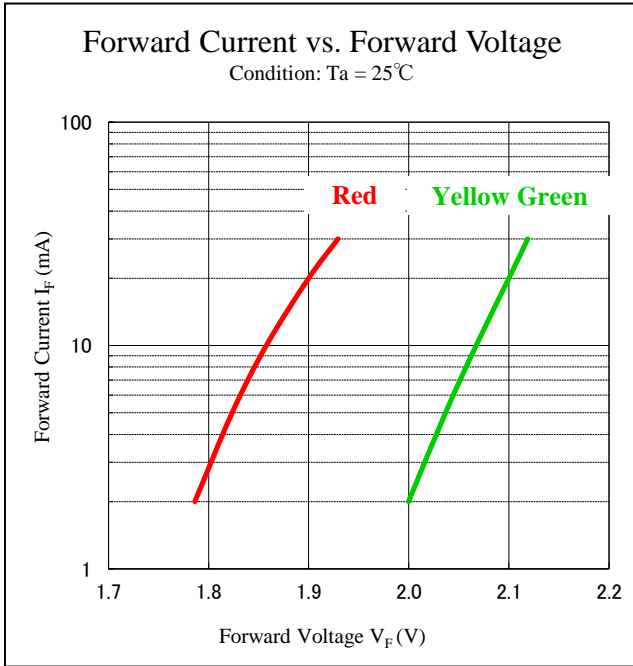
Dominant wavelength (λ_d) Rank LED 2 (Yellow-Green)

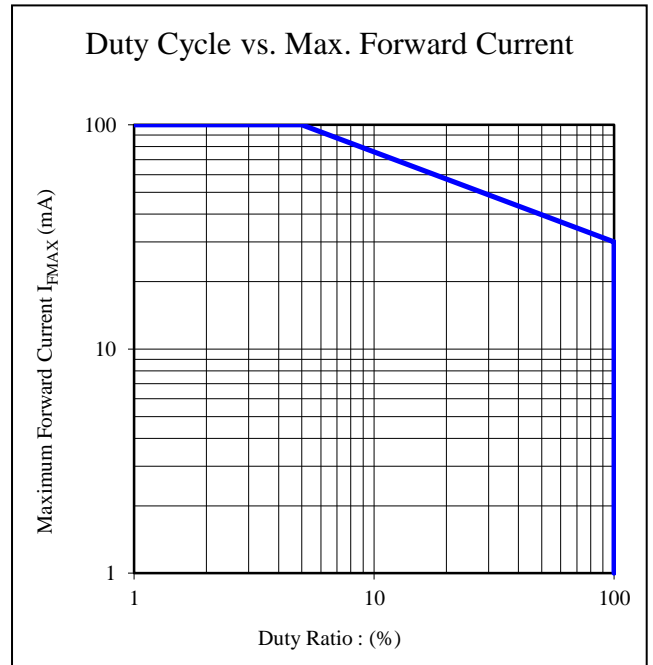
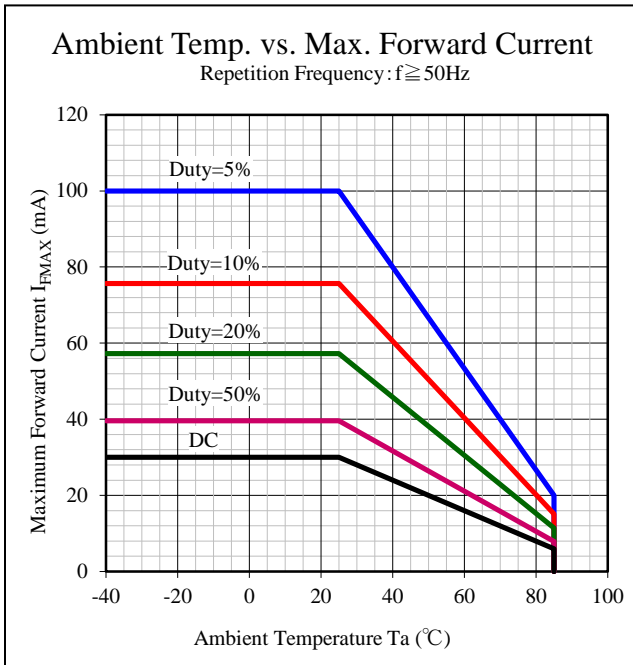
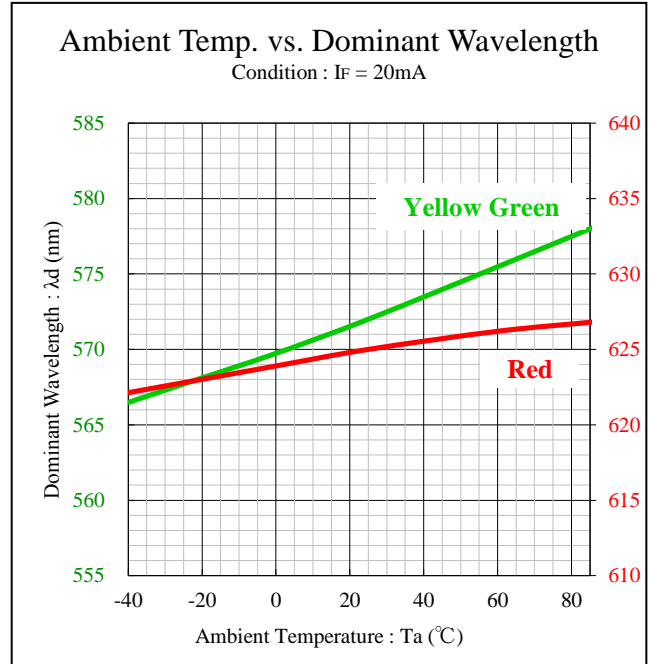
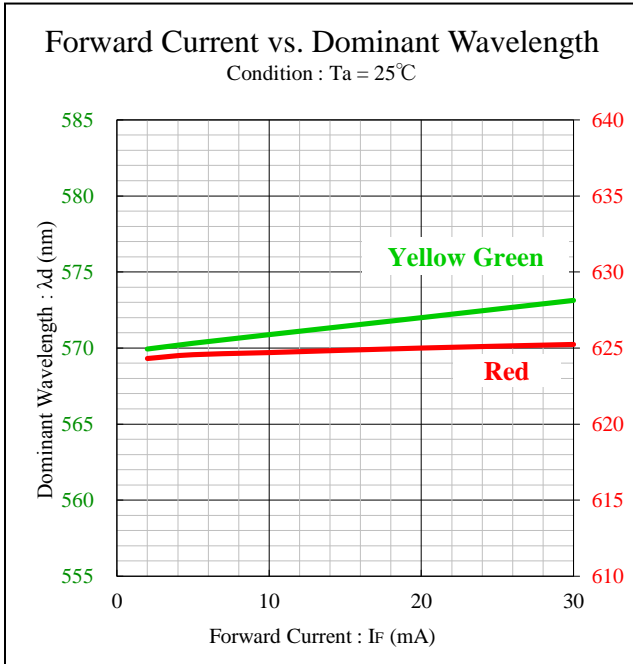
| Rank | λ _d (nm) | | CONDITIONS |
|------|---------------------|------|--|
| | MIN. | MAX. | |
| A | 566 | 570 | I _F =20mA T _a =25°C |
| B | 570 | 574 | |
| C | 574 | 578 | |

Notes

Above the table of Luminous Intensity (I_v) values and Dominant wavelength (λ_d) values are the setup value of the selection machine. 【Tolerance : I_v...±10%、λ_d...±2nm】





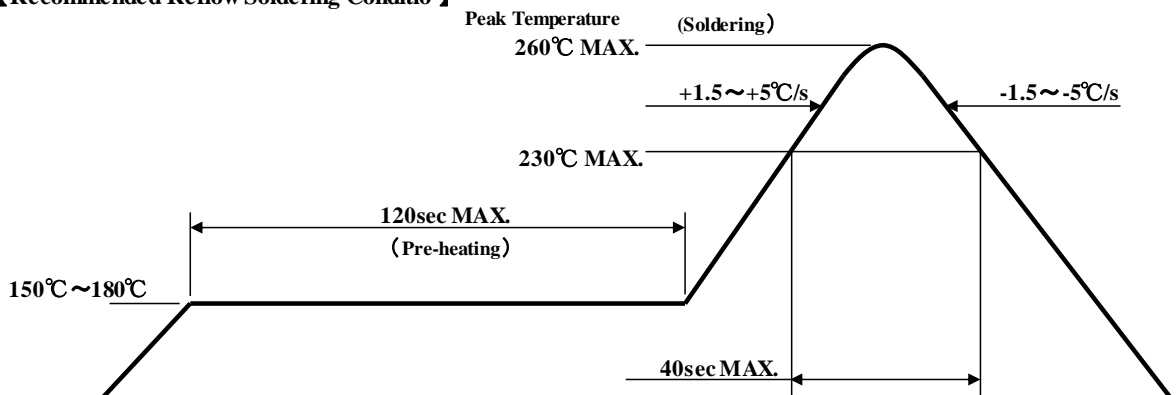


【Soldering Precaution】

(acc.to EIAJ-4701/300)

1. Heat stress during soldering will influence the reliability of LEDs, however that effect will vary on heating method. Also, if components of varying shape are soldered together, it is recommended to set the soldering pad temperature according to the component most vulnerable to heat (e.g., surface mount LED).
2. LED parts including the resin are not stable immediately after soldering (when they are not at room temperature), any mechanical stress may cause damage to the product. Please avoid such stress after soldering, especially stacking of the boards which may cause the boards to warp and any other types of friction with hard materials.
3. High hardness silicone resin is used for this product's lens, but the silicone resin has the characteristic that softens at the high temperature. There is a possibility of causing the transformation, the breakage, and peeling off of the lens when it touches the resin lens at the high temperature such as immediately after soldering. Please avoid touching the lens at the high temperature.
4. Recommended temperature profile for the Reflow soldering is listed as the temperature of the resin surface. Temperature distribution varies on heating method, PCB material, other components in the assembly, and mounting density .
Please do not repeat the heating process in Reflow process more than twice.

【Recommended Reflow Soldering Conditio】



Notes 1 Temperature Profile for the reflow should be set to the surface temperature of resin which is on the top of LED. This should be the maximum temperature for soldering. Lowering the heating temperature and decreasing heating time is very effective in achieving higher reliability.

Notes 2 The reflow soldering process should be done up to twice(2 times Max). When second process is performed, interval between first and second process should be as short as possible to prevent absorption of moisture to resin of LED. The second soldering process should not be done until LEDs have returned to room temperature (by nature-cooling) after first soldering process.

5. If soldering manually, Stanley recommends using a soldering iron equipped with temperature control. During the actual soldering process, make sure that the soldering iron never touches the LED itself, and avoid the LED's electrode heating temperature reaching above the heating temperature of the solder pad. All repairs must be performed only once in the same spot, and please avoid reusing components.
6. In soldering process, immediately after iron tip is cleaned, please make sure that the soldering iron reaches the appropriate temperature, before using. Also, please avoid applying any types of pressure to the soldered components before the solder has been cooled and hardened, as it may deteriorate solder performance and solder quality.

【Recommended Manual Soldering Condition】

| | |
|--------------------------|--------------------|
| Temperature of Iron Tip | 350°C MAX. |
| Soldering Duration, Time | 3sec. Max., 1 time |

7. When using adhesive material for tentative fixatives, thermosetting resin or Ultraviolet radiation (UV) setting resin with heat shall be recommended.
8. When cleaning, Ethyl alcohol, isopropyl alcohol and pure water shall be recommended. Some chemicals, including Freon substitute detergent could corrode or affect the optical characteristics of the lens or the casing surface.
Please review the reference chart below for cleaning.
Cleaning with ultrasonic is strongly recommended after confirming that there is no problem.
9. Flow soldering (dip soldering) is not recommended for this product.

| Chemical | Adaptability |
|-------------------|--------------|
| | ○ / × |
| Ethyl Alcohol | ○ |
| Isopropyl Alcohol | ○ |
| Pure water | ○ |
| Trichloroethylene | × |
| Chloroethene | × |
| Acetone | × |
| Thinner | × |

10. When using freon equivalent solvent, discoloration on the LED surface may be caused by one of the first confirming that there is no problem.

Freon substitute detergent

- Clean through-750H
- Pine alpha ST-100S

11. In the case of water-washing, ensure to use pure water (not city water) and immediately after washing is over, apply forced drying to removed all moisture from the LED.

【Other Precautions】

1. The products are designed to achieve higher performance reliability, however, they can be influenced by usage conditions.
2. Absolute maximum ratings are set to prevent LED products from failing due to excess stress (temperature, current, voltage, etc.). These ratings must never be overrun even for a moment.
3. To achieve the highest performance reliability, it is necessary to take into account, factors such as forward voltage adjusted to the usage temperature condition, derating of the power consumption, and other variable factors.
4. Please insert Straight Protective Resistors into the circuit in order to stabilize LED operation and to prevent the device from igniting due to excess current.
5. Please check the actual performance in the assembly because the Specification Sheets are described for LED device only.
6. Please refrain from looking directly at the light source of LED at high output, as it may harm your vision.
7. The products are designed to operate without failure in recommended usage conditions. However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.
8. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health (such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).
9. When there is a process of supersonic wave welding etc. after mounting the product, there is a possibility of affecting on the reliability of junction part in package (junction part of die bonding and wire bonding). Please use after affirming beforehand there is no problem.
10. The formal specification sheets shall be valid only by exchange of documents by both parties.

This products are baked (moisture removal) before packaging, and are shipped in moisture-proof packaging (as shown below) to minimize moisture absorption during transportation.
 However, in regards to storing the products, the use of dry-box under the following conditions is recommended.
 Moisture-proof bag as the packaging is made of anti-static material but packaging box is not.

【Recommended Storage Condition / Products Warranty Period】

| | |
|-------------|-----------|
| Temperature | +5~30°C |
| Humidity | Under 70% |

In the case of the package unopened , 6 months under 【 Recommended Storage Condition 】.
 Please avoid rapid transition from low temp. condition to high temp. condition and storage in corroding and dusty environment.

【Time elapsed after Package Opening】

The package should not be opened until immediately prior to its use, and please keep the time frame between package opening and soldering which is **【maximum 72 h】**
 If the device needs to be soldered twice, both soldering must be completed within 72h.

If any components should remain after their use, please seal the package and store them under the conditions Described in the 【 Recommended Storage Condition 】.

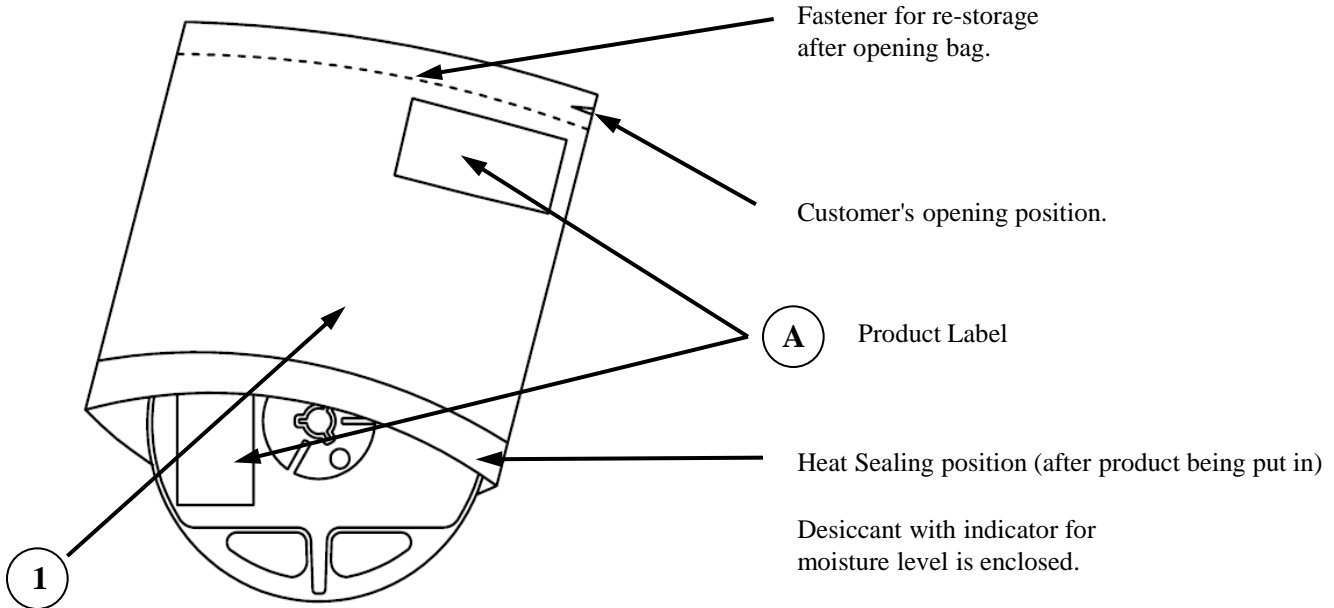
The product must be required to perform baking process (moisture removal) for **at least 10h and not exceed for 12h , at 60+/-5 degrees C** if following conditions apply.

1. In the case of color of indicators (those are in the package of desiccant) change or lose its blue color.
2. In the case of time is passed for 72h after the package is opened once.

Please backing process must be performed after putting out from package.

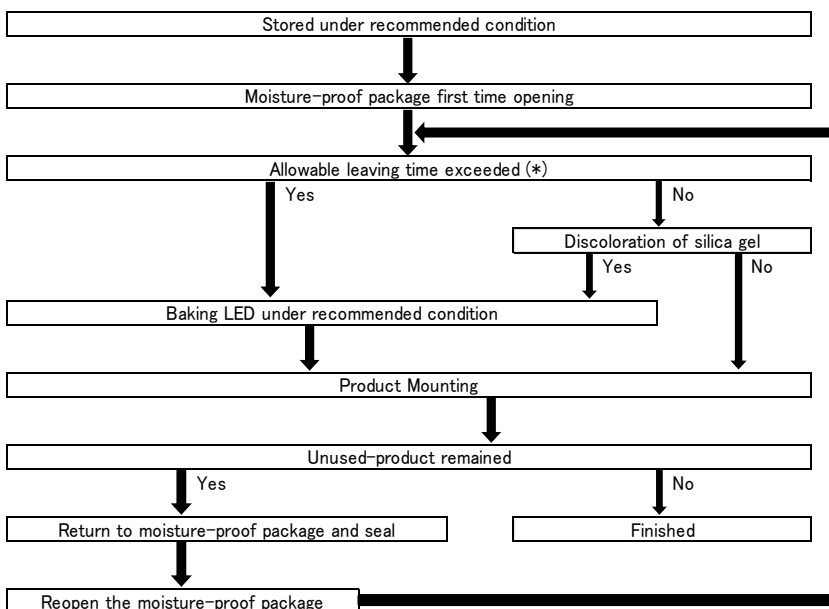
Baking may be performed in the tape-reel form, however if it is performed with the reel stacked over one another, it may case deformation of the reels and taping materials, which may cause problems during production.
 Please make sure that the product has cooled to normal temperature after performing the baking process.
 Provided that, baking process shall be 2 times MAX.

【Moisture-proof Packaging Specification】



| NO. | PART NAME | MATERIALS | REMARKS |
|-----|--|-----------|---------------------|
| ① | Moisture-proof bag with Aluminum layer | PET+Al+PE | with ESD protection |

【Flow Chart-package Opening to Mounting】



Allowable leaving time means the maximum allowable leaving time after opening package, which depends on each LED type. The allowable leaving time should be calculated from the first opening of package to the time when soldering process is finished. When judging if the allowable leaving time has exceeded or not, please subtract the soldering time. The allowable leaving time after reopening should be calculated from the first opening of package, or from the time when baking process is finished.

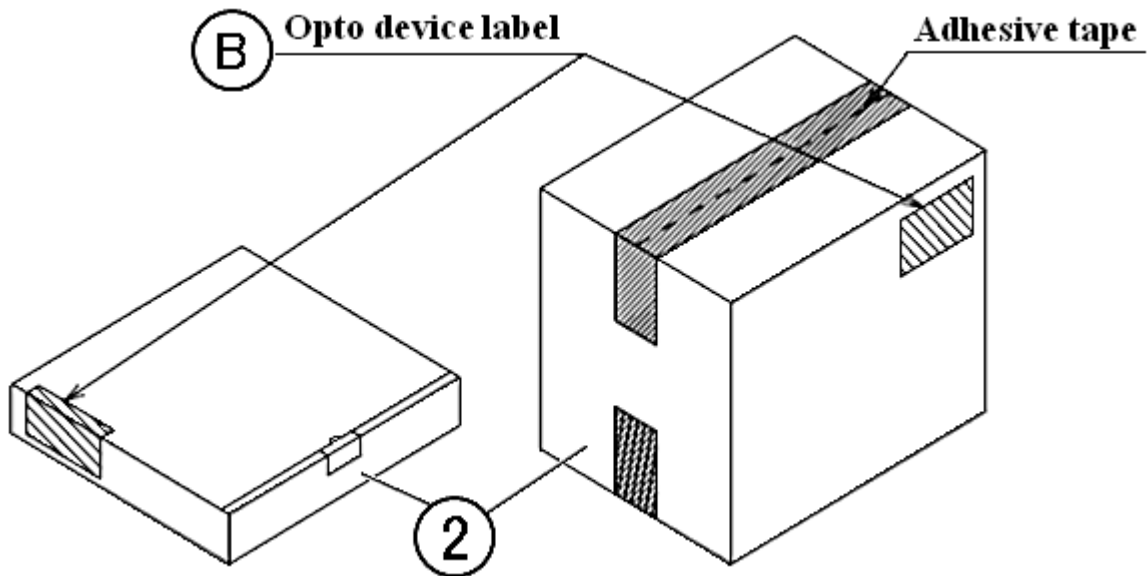
【Packing box】

(RoHS・ELV Compliant)

| Box TYPE | Outline dimension L × W × H (mm) | Capacity of the box |
|----------|-------------------------------------|---------------------|
| Type A | 280 × 265 × 45 | 3 reel |
| Type B | 310 × 235 × 265 | 15 reel |
| Type C | 440 × 310 × 265 | 30 reel |

The above measure is all the reference value.

The box is selected out of the above table by shipping quantity.



Type A

Material / box : Cardboard C5BF

Type B,C

Material / box : Cardboard K5AF

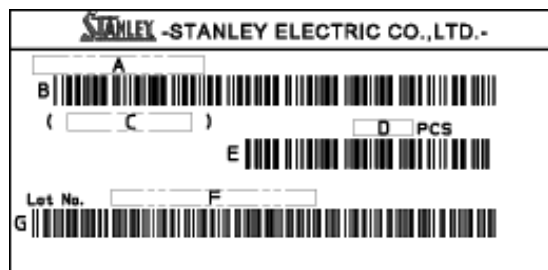
Partition : Cardboard K5BF

| NO. | PART NAME | MATERIAL | REMARKS |
|-----|-------------|---------------------|------------------------|
| ② | Packing Box | Corrugated Cardbord | without ESD protection |

(acc.to JIS-X0503(Code-39))

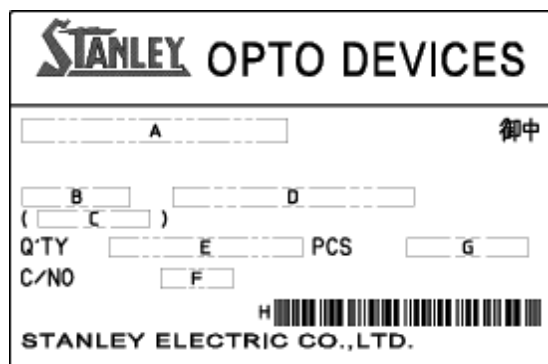
【Label Specification】

A Product label



- A. Parts number
 - B. Bar-code for parts number
 - C. Parts code (In-house identification code for each parts number)
 - D. Packed parts quantity
 - E. Bar-Code for packed parts quantity
 - F. Lot number & Rank
- (Please refer to Lot Number Notational System for details)
- G. Bar-Code for Lot number & Rank

B Opto device label



- A. Customer Name
- B. Parts Type
- C. Parts Code
- D. Parts Number
- E. Packed Parts Quantity
- F. Carton Number
- G. Shipping Date
- H. Bar-Code for In-house identification Number

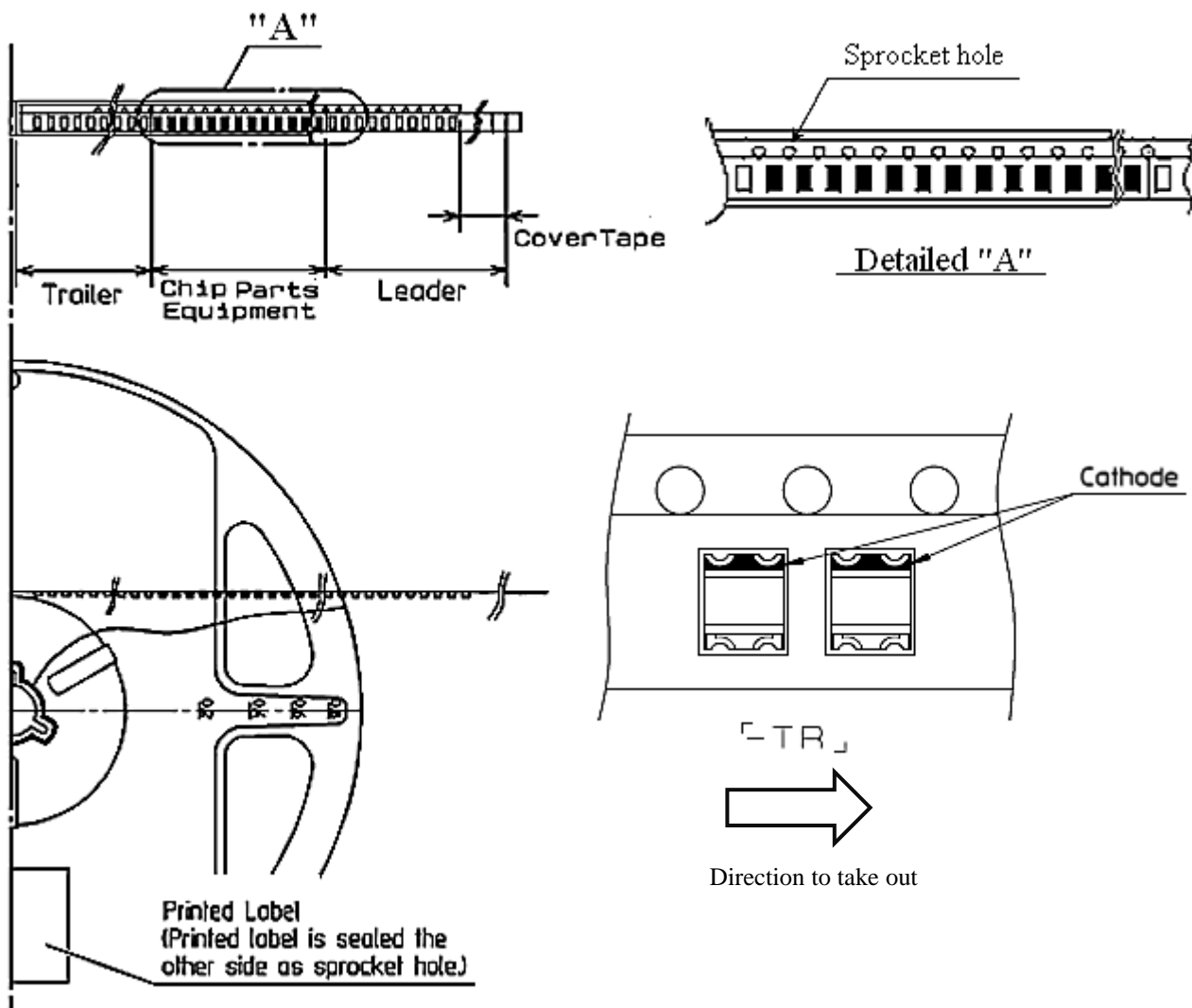
<Remark> Bar-code font : acc.to Code-39(JIX0503)

Taping and Reel Specifications

DRD1204W-TR

(acc.to JIS-C0806-03)

【Appearance】



Note

"-TR" means Cathode Side of LEDs should be placed on the sprocket-hole side.

| Items | | Specifications | Remarks |
|--------------|--------------|---|--|
| Leader area | Cover-tape | Cover-tape shall be longer than 200mm without carrier-tape | The end of cover-tape shall be held with adhesive tape. |
| | Carrier-tape | Empty pocket shall be more than 10 pieces. | Please refer to the above figure for Taping & reel orientation . |
| Trailer area | | Empty pocket shall be more than 15 pieces. | The end of taping shall be inserted into a slit of the hub. |

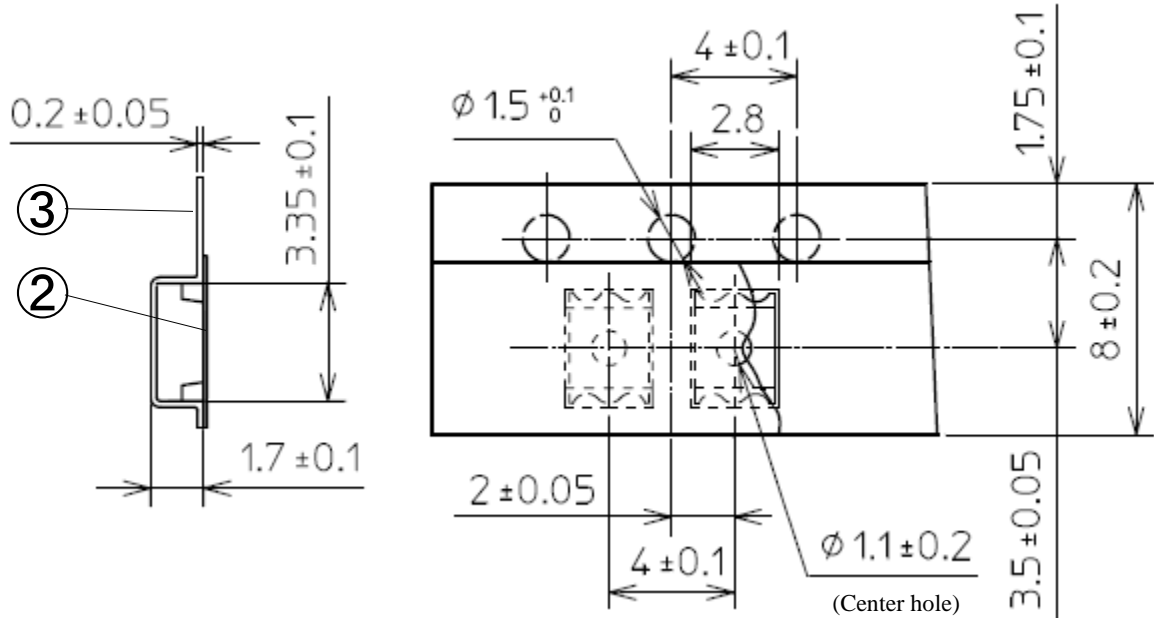
Taping and Reel Specifications

DRD1204W-TR

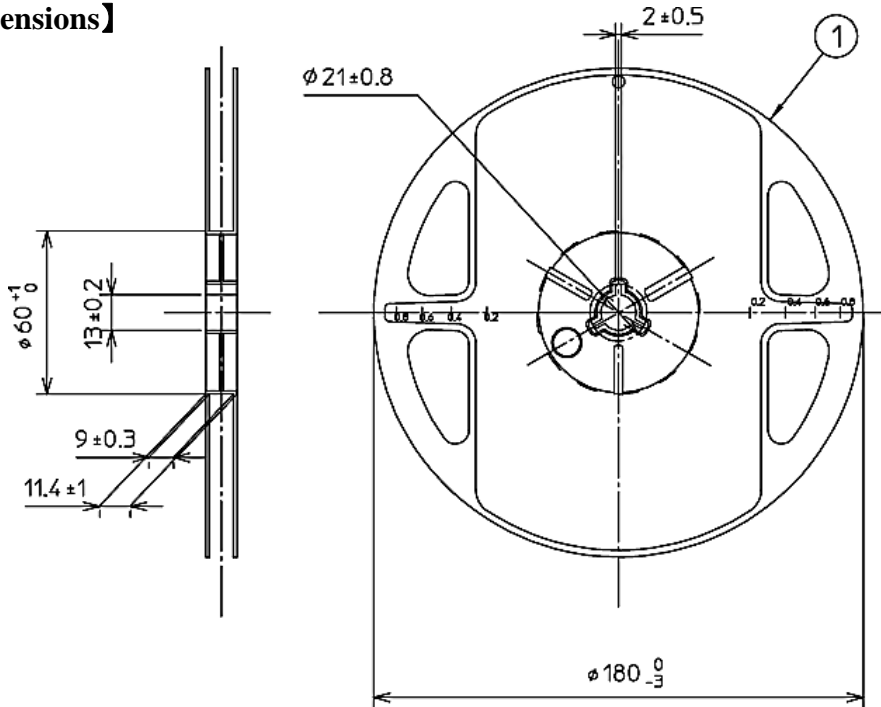
(acc.to JIS-C0806-03)

Unit :mm

【Taping Dimensions】



【Reel Dimensions】



| NO. | PART NAME | REMARKS |
|-----|--------------|---------------------|
| ① | Carrier reel | with ESD protection |
| ② | Cover tape | with ESD protection |
| ③ | Carrier tape | with ESD protection |

Taping and Reel Specifications

DRD1204W-TR

(acc.to JIS-C0806-03)

【 Qty. per Reel】

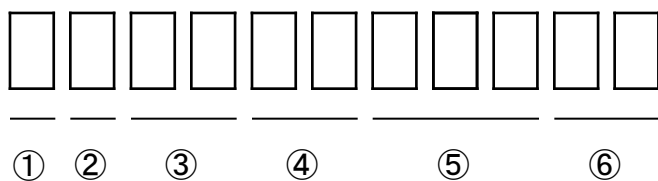
2,500 pcs./ reel

【Mechanical strength】

Cover-tape adhesive strength shall be 0.1~1.0N (An angle between carrier-tape and cover-tape shall be 170 deg.).
Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

【 Others】

- Reversed-orientation, Up-side down placing, side placing and out of spec. parts mix shall not be held.
- The number of empty pockets within a reel is made into 5pcs. or less and no more than 1 connecting empty pockets of taping.



① - 1digit : Production Location (Mark identify alphabet)

② - 1digit : Production Year (Last digit of Production Year 2009→9,2010→0,2011→1,···)

③ - 2digits : Production Month (Jan. to Sep. , should be 01,02,03,·····)

④ - 2digits : Production Date

⑤ - 3digits : Serial Number

⑥ - 2digits : Tape and Reel following Number

This product is in compliance with RoHS・ELV.

Prohibition substance and it's criteria value of RoHS・ELV are as follows.

- RoHS instruction Refer to following (1)~(6).
- ELV instruction Refer to following (1)~(4).

| | Substance Group Name | Criteria Value |
|-----|---------------------------|----------------|
| (1) | Lead and its compounds | 1,000ppm Max |
| (2) | Cadmium and its compounds | 100ppm Max |
| (3) | Mercury and its compounds | 1,000ppm Max |
| (4) | Hexavalent chromium | 1,000ppm Max |
| (5) | PBB | 1,000ppm Max |
| (6) | PBDE | 1,000ppm Max |

1. Reliability Testing Result

| Test Item | Standard | Test Condition | Duration | Failure |
|-----------------------------------|------------------------|--|----------------------|---------|
| Operating Life | EIAJ ED-4701 /100(101) | Ta = 25°C, I _F = 30mA | 1,000h | 0 / 25 |
| High Temperature Storage Life | EIAJ ED-4701 /200(201) | Ta = 100°C | 1,000h | 0 / 25 |
| Low Temperature Storage Life | EIAJ ED-4701 /200(202) | Ta = -40°C | 1,000h | 0 / 25 |
| Wet High Temperature Storage Life | EIAJ ED-4701 /100(101) | Ta=60°C±2°C, Rh=90%±5% | 1,000h | 0 / 25 |
| Thermal Shock | EIAJ ED-4701 /100(105) | Ta= 100°C ~ -40°C (each 15min) | 5 cycles | 0 / 25 |
| Resistance to Reflow Soldering | EIAJ ED-4701 /300(301) | Preheating : 150~180°C 120s Max. Soldering : 230°C 40s Max. Peak Temperature : 260°C | 2times | 0 / 25 |
| Vibration, Variable Frequency | EIAJ ED-4701 /400(403) | 98.1m/s ² (10G) 100~2,000Hz 20min Sweep XYZ direction | 2h of each direction | 0 / 10 |

2. Failure Criteria

| Item | Symbol | Condition | Failure Criteria |
|---------------------|----------------|--------------------|--|
| Luminous Intensity | I _V | 20mA | Testing Min. Value < Standard Min. Value × 0.5 |
| Forward Voltage | V _F | 20mA | Testing Max. Value ≥ Standard Max. Value × 1.2 |
| Reverse Current | I _R | V _R =5V | Testing Max. Value ≥ Standard Max. Value × 2.5 |
| Cosmetic appearance | - | - | Notable, decollation, deformation and cracking |

Special Notice to Customers Using the Products and Technical Information Shown in This Data Sheet

- 1) The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.
- 2) For the purpose of product improvement, the specifications, characteristics and technical data described in the data sheets are subject to change without prior notice. Therefore it is recommended that the most updated specifications be used in your design.
- 3) When using the products described in the data sheets, please adhere to the maximum ratings for operating voltage, heat dissipation characteristics, and other precautions for use. We are not responsible for any damage which may occur if these specifications are exceeded.
- 4) The products that have been described to this catalog are manufactured so that they will be used for the electrical instrument of the benchmark (OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument).
The application of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. needs a high reliability and safety, and the breakdown and the wrong operation might influence the life or the human body. Please consult us beforehand if you plan to use our product for the usages of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. except OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument.
- 5) In order to export the products or technologies described in this data sheet which are under the “Foreign Exchange and Foreign Trade Control Law,” it is necessary to first obtain an export permit from the Japanese government.
- 6) No part of this data sheet may be reprinted or reproduced without prior written permission from Stanley Electric Co., Ltd.
- 7) The most updated edition of this data sheet can be obtained from the address below:
<http://www.stanley-components.com/en/>

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9